

# ICEBA 2025

THE 6<sup>TH</sup> INTERNATIONAL CONFERENCE  
ON ENGINEERING, PHYSICS, MEMS-BIOSENSORS AND APPLICATIONS  
NOVEMBER 10-12, 2025

## INVITATION LETTER

On behalf of the Organizing Committee, we are honored to invite you to **contribute a research paper to the 6th International Conference on Engineering, Physics, MEMS-Biosensors and Applications (ICEBA 2025)**. The conference is hosted by **Eastern International University (EIU)**, in collaboration with **VNUHCM-University of Science (Vietnam)** and **Tohoku University (Japan)**, and will take place **from November 10th to 12th, 2025**, at Eastern International University, Binh Duong Province, Vietnam.

The primary objective of ICEBA 2025 is to foster connections among researchers and scientists from Vietnam and across the globe, with a particular focus on Asia. The conference will cover diverse fields, including engineering, physics, microelectronics, semiconductors, electronic engineering and their applications in biomedical engineering, health sciences, high-tech agriculture and smart cities. Furthermore, ICEBA 2025 aims to enhance international collaboration through research partnerships, joint publications and propose innovative solutions along with applied technology to advance Vietnam's education and technological development.

The conference will feature parallel oral presentations and poster sessions, providing an excellent platform for participants to share their research and engage in insightful discussions with fellow academics.

We encourage participants to submit their abstracts via our **EasyChair submission link** before **June 30th, 2025: [LINK](#)**

**High-quality papers** will undergo a rigorous peer-reviewed process and may be recommended for publication in one of the following ISI/Scopus-indexed international journals (publication fee required):

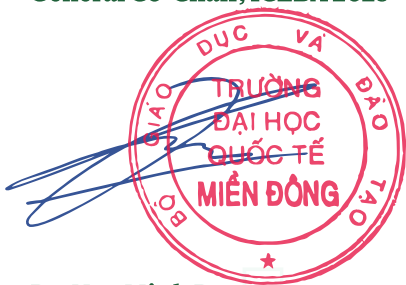
1. **IEEEJ Transactions on Electrical and Electronic Engineering on ICEBA (Scopus, Q3);**
2. **The special issue of Chinese Journal of Physics (Q2);**
3. **Arabian Journal for Science and Engineering (Springer, IF: 2.6, Q1), with publication fees fully waived for ICEBA 2025 participants.**

For more information, please visit our website: <https://iceba.eiu.edu.vn/> or contact us via email: [iceba@eiu.edu.vn](mailto:iceba@eiu.edu.vn)

We look forward to your participation and contribution to the success of ICEBA 2025.

Best regards,

**General Co-Chair, ICEBA 2025**



**Dr. Ngo Minh Duc**

President

Eastern International University